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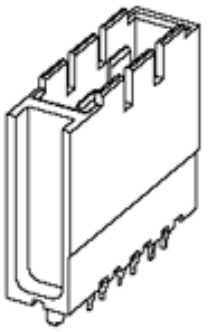
Part Number: 0754921076
Status: Active
Overview: gbx_backplane_connector_system
Description: 1.85mm by 1.85mm (.073 by .073") Pitch 2-Pair GbX® Backplane Connector System, Power Module, 4 Circuits, 1.27µm (50µ") Gold (Au)



Series image - Reference only

Documents:
Drawing (PDF)
RoHS Certificate of Compliance (PDF)
Product Specification PS-75221-999 (PDF)

Agency Certification

UL	E29179

General

Product Family	Backplane Connectors
Series	75492
Application	Backplane
Application Tooling Documents	Tooling Manual
Comments	Blade Length A 7.50mm, B 6.00mm
Component Type	Power Header
Overview	gbx_backplane_connector_system
Product Name	GbX®
Style	N/A

Physical

Circuits (Loaded)	4
Circuits (maximum)	4
Circuits Detail	Rows A & B
Color - Resin	Gray (Dark)
Durability (mating cycles max)	200
First Mate / Last Break	Yes
Flammability	94V-0
Guide to Mating Part	No
Keying to Mating Part	None
Material - Metal	High Performance Alloy (HPA)
Material - Plating Mating	Gold
Material - Plating Termination	Tin-Lead
Material - Resin	High Temperature Thermoplastic
Number of Columns	N/A
Number of Pairs	2
Number of Rows	2
Orientation	Vertical
PC Tail Length (in)	0.090 In
PC Tail Length (mm)	2.28 mm
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness Recommended (in)	0.063 In
PCB Thickness Recommended (mm)	1.60 mm
Packaging Type	Tube
Pitch - Mating Interface (in)	0.730 In
Pitch - Mating Interface (mm)	1.85 mm
Pitch - Term. Interface (in)	0.102 In
Pitch - Term. Interface (mm)	2.60 mm
Plating min: Mating (µin)	50
Plating min: Mating (µm)	1.25

EU RoHS
RoHS Compliant by Exemption
REACH SVHC
Contains SVHC: No
Halogen-Free Status
Halogen-Free

China RoHS
50
Pb

Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, click here

Please visit the Contact Us section for any non-product compliance questions.

Search Parts in this Series
75492Series

Mates With
75292 GbX® Daughtercard

Application Tooling | **FAQ**
Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

Description	Product #
GbX® Shield Removal Tool	0622022100
GbX® 2 Pair 1-Up Power Module	0622022480

Plating min: Termination (µin)	30
Plating min: Termination (µm)	0.75
Polarized to PCB	Yes
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	105°C
Termination Interface: Style	Through Hole - Compliant Pin

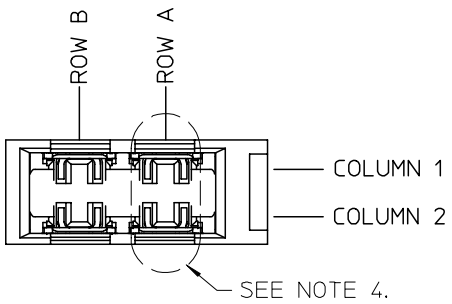
Electrical

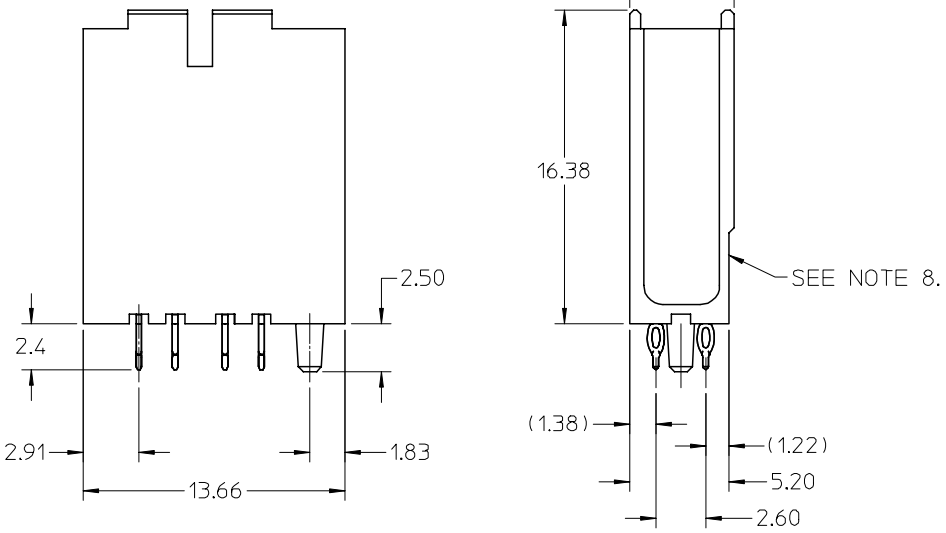
Current - Maximum per Contact	6A
Data Rate	8.0 Gbps
Shielded	No
Voltage - Maximum	120V AC (RMS)/DC

Material Info

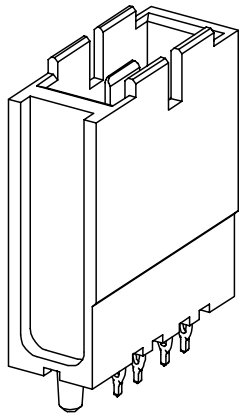
Reference - Drawing Numbers

Packaging Specification	PK-70873-578
Product Specification	PS-75221-999
Sales Drawing	SD-75492-001





NOTES:
1. MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP), UL 94V-0, GRAY; CONTACT - COPPER ALLOY
2. FINISH: SELECT GOLD IN CONTACT AREA, 50 µ" THICK; TIN/LEAD OR MATTE TIN IN COMPLIANT AREA.
3. PACKAGING PER PK-70873-578.
4. CONTACTS IN EACH ROW HAVE THE SAME WIPE LENGTH.
5. BACKPLANE ASSEMBLY MATES WITH DAUGHTERCARD POWER MODULE 75292-2***.
6. PART SHOWN IS 75492-1067.
7. SEE OTHER SHEETS FOR ADDITIONAL NOTES.
8. WHEN INSERTING OPEN SIGNAL MODULES NEXT TO COLUMN 1 SIDE OF POWER MODULES, SIGNAL MODULES MUST BE INSERTED BEFORE THE POWERS TO AVOID INTERFERENCE BETWEEN THE TWO CONNECTOR HOUSINGS.
9. THESE PARTS CONFORM TO MOLEX PRODUCT SPECIFICATION PS-75221-999.
10. THESE PARTS CONFORM TO MOLEX COSMETIC SPECIFICATION PS-45499-002 CLASS B.



1-UP ASSEMBLY PART NUMBER

7 5 4 9 2 - 1 0 A B

- TIN/LEAD PLATED PRODUCT -
FOR EACH ROW LOCATION A, B:
4 = 4.5 mm
6 = 6.0 mm
7 = 7.5 mm
- LEAD-FREE PLATED PRODUCT -
FOR EACH ROW LOCATION A, B:
2 = 4.5 mm
3 = 6.0 mm
5 = 7.5 mm

SEE SHEET 4 FOR HOLE PATTERN LAYOUT

REV	DESCRIPTION	
C	ADDED NOTES 9 & 10 EC NO: UCP2008-0426	2007/08/29
	DRWN: CSTEWART	2007/08/30
	CHKD: JB NGHAM	2007/08/31
	APPR: JB NGHAM	

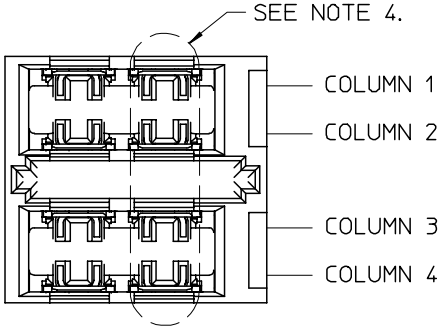
QUALITY SYMBOLS
▼=0
▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± ---	± ---
1 PLACE	± ---	± ---
ANGULAR ± 5 °		

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

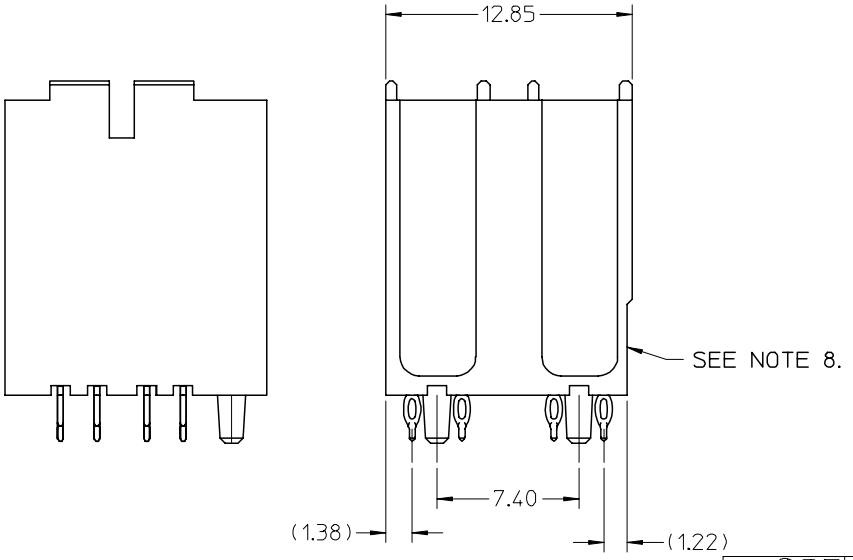
DIMENSION STYLE	MM ONLY
SCALE	4:1
DESIGN UNITS	METRIC
	THIRD ANGLE PROJECTION
DRAWN BY	ELO
DATE	2005/07/01
CHECKED BY	ELO
DATE	2005/07/01
APPROVED BY	BIXLER
DATE	2005/07/06
MATERIAL NO.	SEE CHART
TITLE	GBX 2 PAIR BACKPLANE POWER SALES ASSEMBLY
	MOLEX INCORPORATED
DOCUMENT NO.	SD-75492-001
SHEET NO.	1 OF 4
SIZE	B

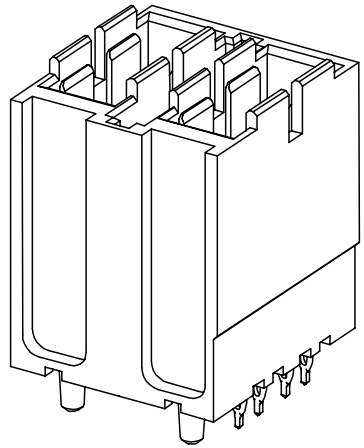


2-UP ASSEMBLY PART NUMBER

75492-20AB

- TIN/LEAD PLATED PRODUCT -
FOR EACH ROW LOCATION A, B:
4 = 4.5 mm
6 = 6.0 mm
7 = 7.5 mm
- LEAD-FREE PLATED PRODUCT -
FOR EACH ROW LOCATION A, B:
2 = 4.5 mm
3 = 6.0 mm
5 = 7.5 mm





SEE SHEET 1 FOR ADDITIONAL INFORMATION
CHECK WITH PRODUCT MANAGER FOR AVAILABILITY

SEE SHEET ONE
EC NO: UCP2008-0426 2007/08/29
DRWN: CSTEWART 2007/08/30
CH'KD: JB INGHAM 2007/08/31
APPR: JB INGHAM
DESCRIPTION
REV

QUALITY SYMBOLS
▼=0
▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

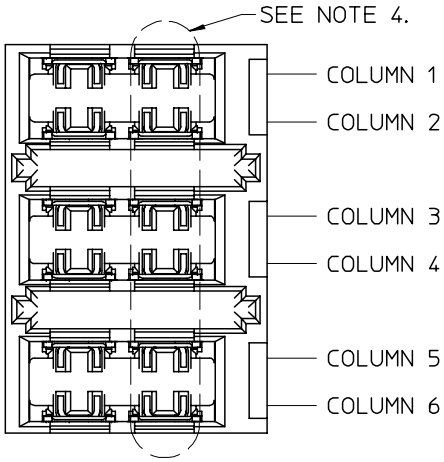
	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± ---	± ---
1 PLACE	± ---	± ---
ANGULAR ± 5 °		

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: MM ONLY
SCALE: 4:1
DESIGN UNITS: METRIC
THIRD ANGLE PROJECTION

DRAWN BY: ELO DATE: 2005/07/01
CHECKED BY: ELO DATE: 2005/07/01
APPROVED BY: BIXLER DATE: 2005/07/06
MATERIAL NO.: SEE CHART

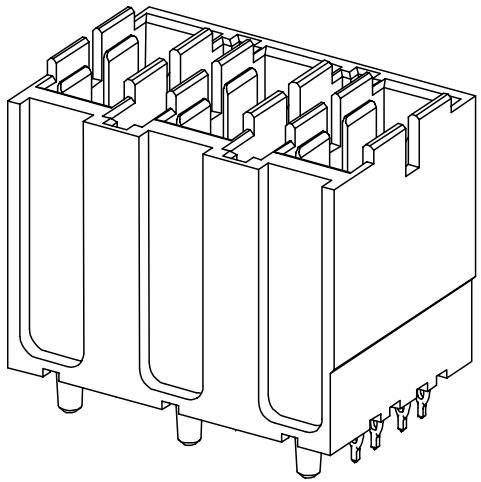
TITLE: GBX 2 PAIR BACKPLANE POWER SALES ASSEMBLY
MOLEX INCORPORATED
DOCUMENT NO.: SD-75492-001
SHEET NO.: 2 OF 4
SIZE: B

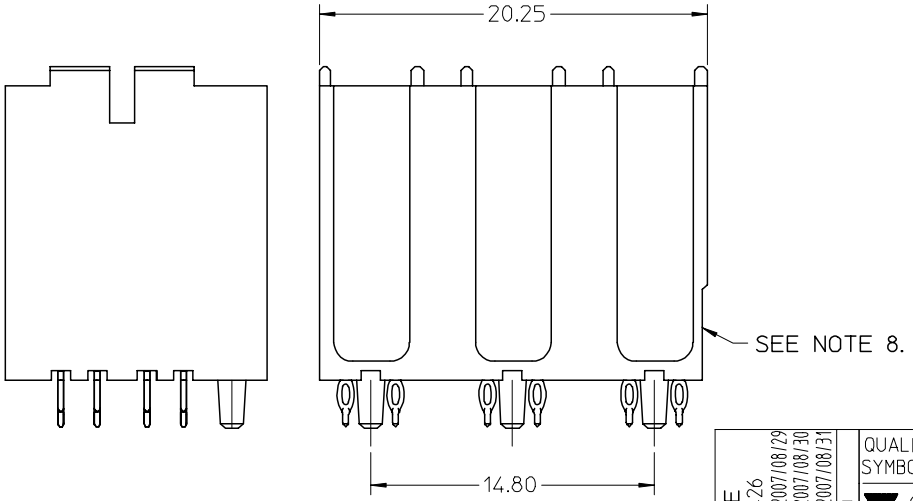


3-UP ASSEMBLY PART NUMBER

7 5 4 9 2 - 3 0 A B

- TIN/LEAD PLATED PRODUCT -
FOR EACH ROW LOCATION A, B:
4 = 4.5 mm
6 = 6.0 mm
7 = 7.5 mm
- LEAD-FREE PLATED PRODUCT -
FOR EACH ROW LOCATION A, B:
2 = 4.5 mm
3 = 6.0 mm
5 = 7.5 mm





SEE SHEET 1 FOR ADDITIONAL INFORMATION
CHECK WITH PRODUCT MANAGER FOR AVAILABILITY

SEE SHEET ONE
EC NO: UCP2008-0426 2007/08/29
DRWN: CSTEWART 2007/08/30
CH'KD: JB NGHAM
APPR: JB NGHAM 2007/08/31
DESCRIPTION
REV

QUALITY SYMBOLS
▼=0
▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± ---	± ---
1 PLACE	± ---	± ---
ANGULAR ± 5 °		

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: MM ONLY
SCALE: 4:1
DESIGN UNITS: METRIC
THIRD ANGLE PROJECTION

DRAWN BY	ELO	DATE 2005/07/01
CHECKED BY	ELO	DATE 2005/07/01
APPROVED BY	BIXLER	DATE 2005/07/06

TITLE: GBX 2 PAIR BACKPLANE POWER SALES ASSEMBLY

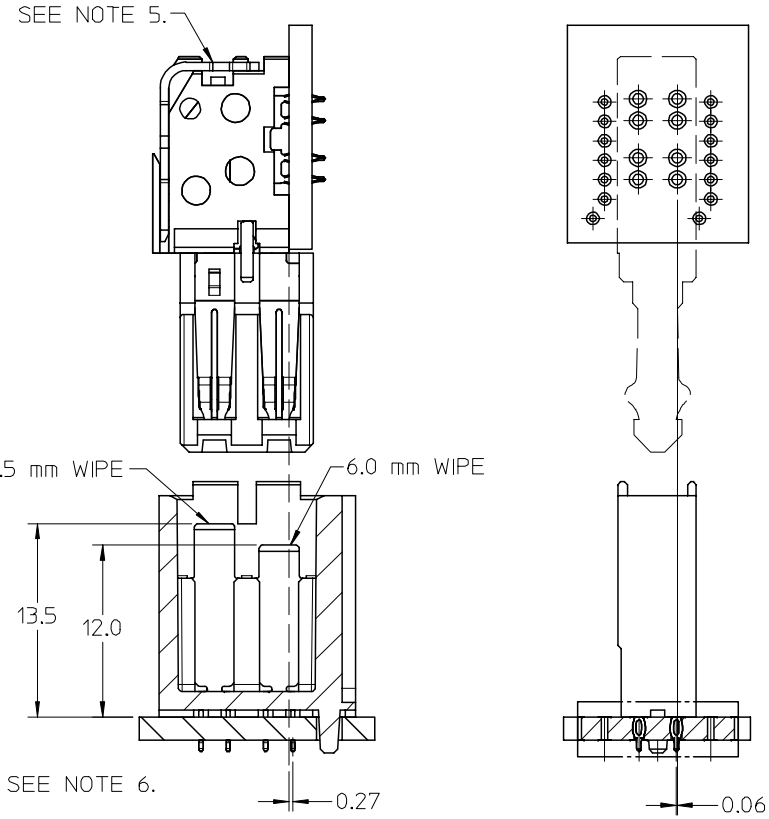
molex MOLEX INCORPORATED

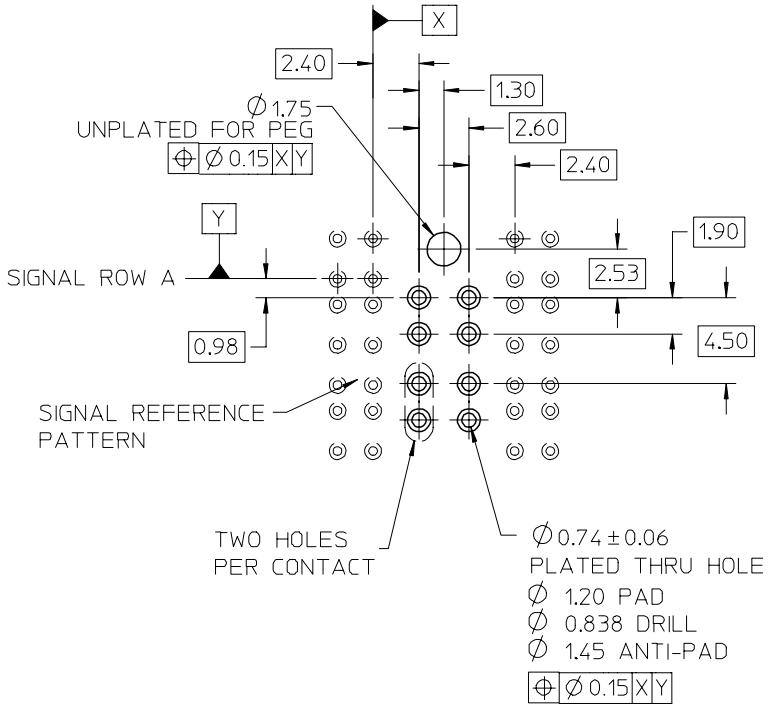
MATERIAL NO.: SEE CHART
DOCUMENT NO.: SD-75492-001
SHEET NO.: 3 OF 4

SIZE B

HOLE PATTERN FOR 1-UP ASSEMBLY

1.) ADD 7.40 FROM CENTERLINES OF PEG FOR MULTIPLE UP ASSEMBLIES
2.) USE 5.55 FROM CENTERLINE TO CENTERLINE OF PEG FOR INDIVIDUAL POWER MODULES STACKED NEXT TO EACH OTHER.





SEE SHEET ONE
EC NO: UCP2008-0426 2007/08/29
DRWN: CSTEWART 2007/08/30
CH'KD: JB NGHAM 2007/08/31
APPR: JB NGHAM
DESCRIPTION
REV

QUALITY SYMBOLS
▼=0
▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± ---	± ---
1 PLACE	± ---	± ---
ANGULAR ± 5 °		

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: MM ONLY
SCALE: 4:1
DESIGN UNITS: METRIC
THIRD ANGLE PROJECTION

		DATE
DRAWN BY	ELO	2005/07/01
CHECKED BY	ELO	2005/07/01
APPROVED BY	BIXLER	2005/07/06

TITLE: GBX 2 PAIR BACKPLANE POWER SALES ASSEMBLY

MOLEX INCORPORATED

MATERIAL NO.: SEE PREVIOUS
DOCUMENT NO.: SD-75492-001
SHEET NO.: 4 OF 4
SIZE: B

Общество с ограниченной ответственностью «МосЧип» ИНН 7719860671 / КПП 771901001
Адрес: 105318, г.Москва, ул.Щербаковская д.3, офис 1107

Данный компонент на территории Российской Федерации

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Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

http://moschip.ru/get-element

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

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Офис по работе с юридическими лицами:

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